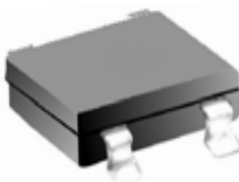


FEATURES

- ✧ Glass passivated junction
- ✧ Ideal for printed circuit board
- ✧ Reliable low cost construction utilizing molded plastic technique
- ✧ High temperature soldering guaranteed:
260°C / 10 seconds / 0.375" (9.5mm)
lead length at 5 lbs., (2.3 kg) tension
- ✧ Small size, simple installation
- ✧ Pure tin plated terminal , Lead free. Leads solderable per MIL-STD-202, Method 208
- ✧ High surge current capability

MECHANICAL DATA

- ✧ Case: Molded plastic body
- ✧ Mounting position : as Marking
- ✧ Weight: 0.12 grams

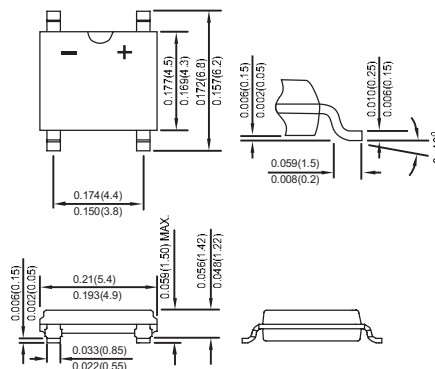


VOLTAGE RANGE

1000 Volts

CURRENT

2.0 Ampere



Dimensions in inches and (millimeters)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

CHARACTERISTICS		RABS210	UNIT
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	1000	V
Maximum RMS Voltage	V_{RMS}	700	V
Maximum DC Blocking Voltage	V_{DC}	1000	V
Maximum Average Forward Rectified Current @ $T_A=40^\circ\text{C}$	$I_{(AV)}$	2.0	A
Peak Forward Surge Current 8.3ms Single Half Sine-Wave Super Imposed on Rated Load (JEDEC .Method)	I_{FSM}	60	A
Maximum Forward Voltage at 1.0A DC	V_F	1.3	V
Maximum DC Reverse Current @ $T_J=25^\circ\text{C}$	I_R	10	μA
at Rated DC Blocking Voltage @ $T_J=125^\circ\text{C}$		500	
I^2t Rating for Fusing ($t < 8.3\text{ms}$)	I^2t	14.94	A^2s
Maximum Reverse Recovery Time (Note1)	T_{RR}	500	ns
Typical Junction capacitance Per Element(Note2)	C_J	25	pF
Typical Thermal Resistance (Note3)	$R_{\theta JA}$	40	$^\circ\text{C/W}$
Operating Temperature Range	T_J	-55 to +150	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$

Note:1. Reverse Recovery Test Conditions: $I_F=0.5\text{A}$, $I_R=1.0\text{A}$, $I_{RR}=0.25\text{A}$.

2.Measured at 1.0MHz and applied reverse voltage of 4.0V DC

3.Thermal resistance from junction to ambient mounted on P.C.B
with 0.5*0.5"(13*13mm) copper pads.

4.The typical data above is for reference only(典型值仅供参考).

RATING AND CHARACTERISTIC CURVES

FIG.1-DERATING CURVE FOR
OUTPUT RECTIFIED CURRENT

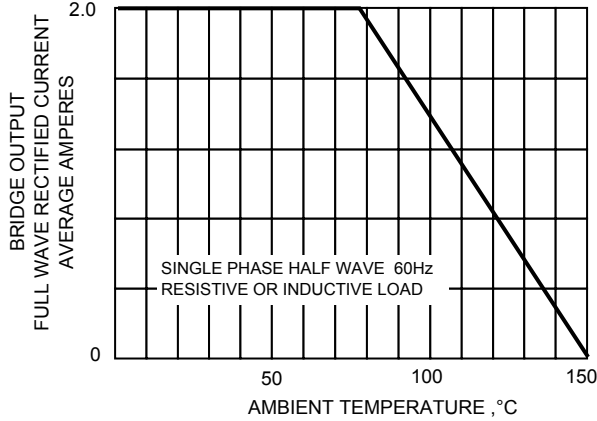


FIG.2-MAXIMUM NON-REPETITIVE PEAK
FORWARD SURGE CURRENT

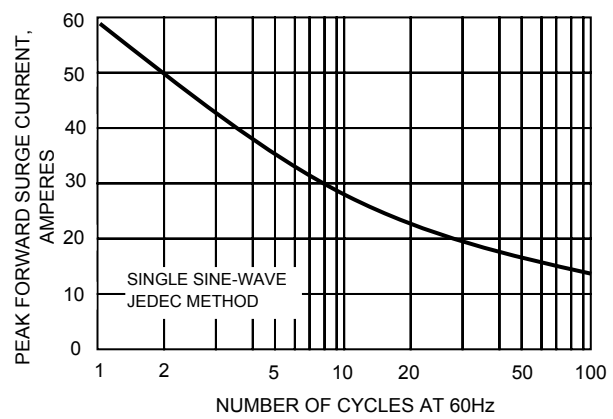


FIG.3-TYPICAL JUNCTION CAPACITANCE

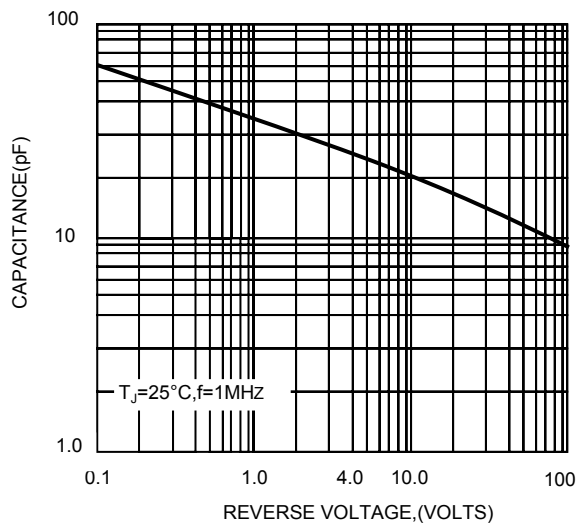


FIG.4-TYPICAL FORWARD CHARACTERISTICS

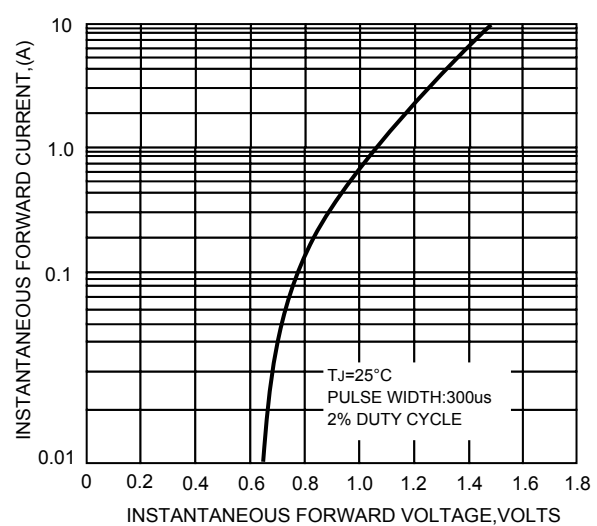
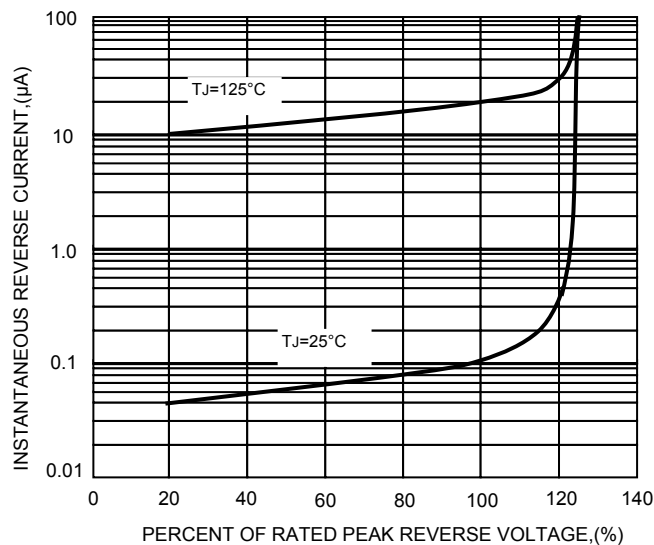


FIG.5-TYPICAL REVERSE CHARACTERISTICS



The curve graph is for reference only, can't be the basis for judgment(曲线图仅供参考)!